

Lonten N-channel 600V, 2A Power MOSFET

Description

The Power MOSFET is fabricated using the advanced planer VDMOS technology. The resulting device has low conduction resistance, superior switching performance and high avalance energy.

Features

- ◆ Low R_{DS(on)}
- Low gate charge (typ. Q_g = 10.2 nC)
- ◆ 100% UIS tested
- RoHS compliant

Applications

- Power factor correction.
- Switched mode power supplies.
- LED driver.

Product Summary								
V_{DSS}	600V							
I_D	2A							
$R_{DS(on),max} \\$	4.5Ω							
$Q_{g,typ}$	10.2	nC						
G D S	Can's	Constant of the second	G D S					
TO-251	TO-252	TO-220	TO-220F					
	G H	S MOSFET	Po					

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	600	V
Continuous drain current (T _C = 25°C)	I _D	2	A
(T _C = 100°C)		1.3	Α
Pulsed drain current 1)	I _{DM}	8	A
Gate-Source voltage	V _{GSS}	±30	V
Avalanche energy, single pulse 2)	E _{AS}	80	mJ
Peak diode recovery dv/dt 3)	dv/dt	5	V/ns
Power Dissipation TO-220F (T _C = 25°C)		27	W
Derate above 25°C		0.22	W/°C
Power Dissipation	P _D		
TO-220\ TO-251\ TO-252 (T _C = 25°C)		35	W
Derate above 25°C		0.28	W/°C
Operating juncition and storage temperature range	T _J , T _{STG}	-55 to +150	°C
Continuous diode forward current	Is	2	Α
Diode pulse current	I _{S,pulse}	8	A

Thermal Characteristics

Parameter	Cumbal		Unit		
Parameter	Symbol	TO-220F	TO-220\TO-251\TO-252	Unit	
Thermal resistance, Junction-to-case	R _{eJC}	4.63	3.57	°C/W	
Thermal resistance, Junction-to-ambient	$R_{\theta JA}$	100	62	°C/W	

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Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube	Units/Real
LNC2N60	TO-220	LNC2N60	50	
LND2N60	TO-220F	LND2N60	50	
LNG2N60	TO-252	LNG2N60		3000
LNH2N60	TO-251	LNH2N60	80	

Electrical Characteristics T_c = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics			•			
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =0.25 mA	600	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =0.25 mA	2	-	4	V
Drain cut-off current	I _{DSS}	V _{DS} =600 V, V _{GS} =0 V,				
		$T_j = 25$ °C	-	-	1	μA
		T _j = 125°C	-		100	
Gate leakage current, Forward	I _{GSSF}	V _{GS} =30 V, V _{DS} =0 V	-	-	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-30 V, V _{DS} =0 V	-	-	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =1 A	-	3.6	4.5	Ω
Dynamic characteristics						
Input capacitance	C _{iss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	-	338	-	
Output capacitance	Coss	f = 1 MHz	-	36	-	pF
Reverse transfer capacitance	C _{rss}		-	3.4	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 300 \text{ V}, I_D = 2 \text{ A}$	-	16.8	-	
Rise time	t _r	$R_G = 10 \Omega, V_{GS}=15 V$	-	35.5	-	ns
Turn-off delay time	t _{d(off)}		-	34.3	-	
Fall time	t _f		-	24.7	-	
Gate charge characteristics			•	•		
Gate to source charge	Q_{gs}	V _{DD} =480 V, I _D =2 A,	-	2.6	-	
Gate to drain charge	Q_{gd}	V _{GS} =0 to 10 V	-	4.7	-	nC
Gate charge total	Q_g		-	10.2	-	
Gate plateau voltage	V _{plateau}		-	5	-	V
Reverse diode characteristics			•			•
Diode forward voltage	V _{SD}	V _{GS} =0 V, I _F =2 A	-	-	1.3	V
Reverse recovery time	t _{rr}	V _R =400 V, I _F =2 A,	-	194	-	ns
Reverse recovery charge	Q _{rr}	dI _F /dt=100 A/µs	-	0.7	-	μC
Peak reverse recovery current	I _{rrm}		-	7.4	-	Α

Notes:

- 1. Pulse width limited by maximum junction temperature.
- 2. L=10mH, I_{AS} = 4A, Starting T_j = 25°C.
- 3. I_{SD} = 2A, di/dt \leq 100A/us, V_{DD} \leq B V_{DS} , Starting T_j = 25°C.

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Electrical Characteristics Diagrams

Figure 1. Typical Output Characteristics

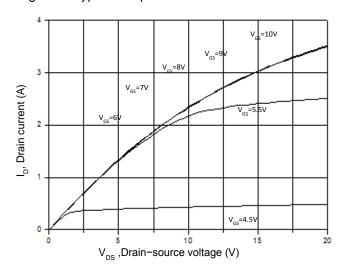


Figure 3. On-Resistance Variation vs. Drain Current

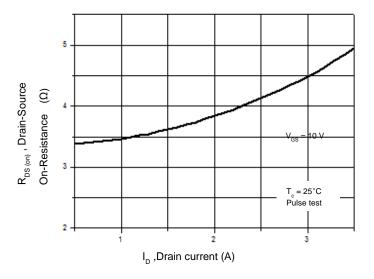


Figure 5. Breakdown Voltage vs. Temperature

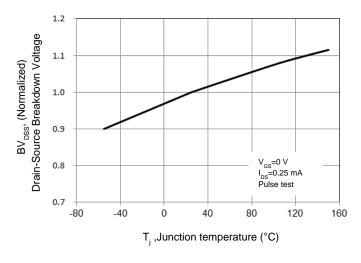


Figure 2. Transfer Characteristics

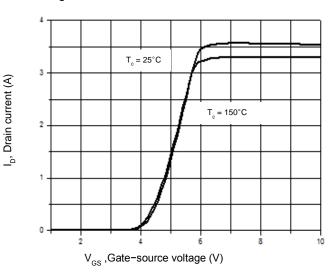


Figure 4. Threshold Voltage vs. Temperature

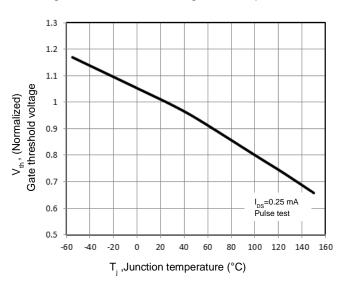


Figure 6. On-Resistance vs. Temperature

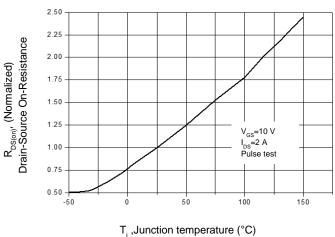




Figure 7. Capacitance Characteristics

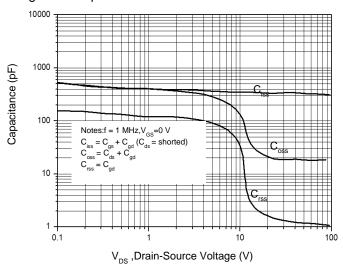


Figure 9. Maximum Safe Operating Area TO-220F

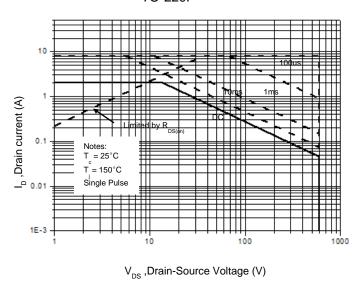


Figure 11. Power Dissipation vs. Temperature TO-220F

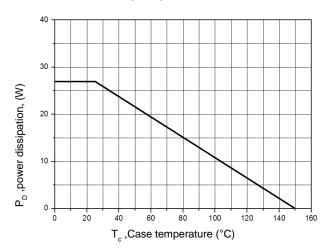
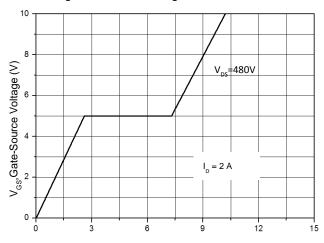


Figure 8. Gate Charge Characterist



Q_G ,Total Gate Charge (nC)

Figure 10. Maximum Safe Operating Area TO-220/ TO-251/TO-252

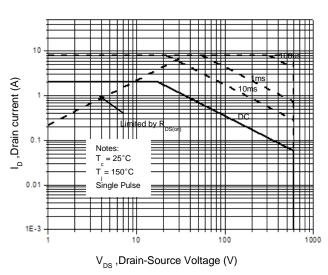
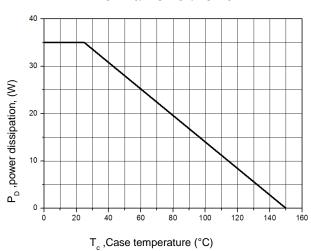


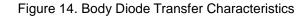
Figure 12. Power Dissipation vs. Temperature TO-220/ TO-251/TO-252

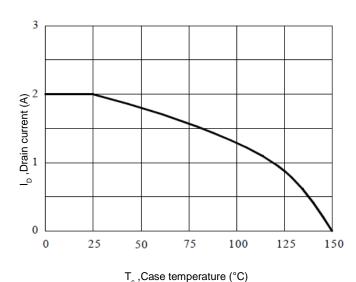


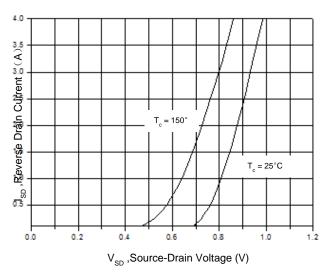
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Figure 13. Continuous Drain Current vs. Temperature









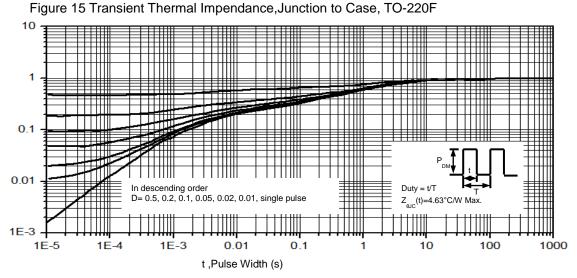
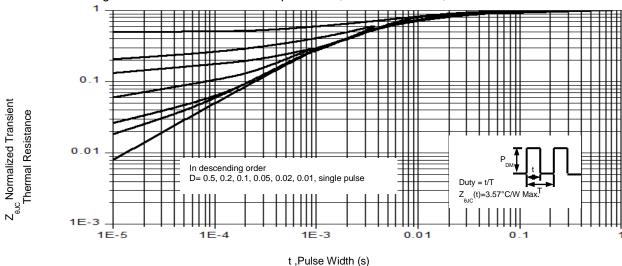


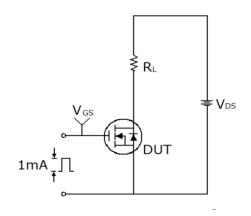
Figure 16. Transient Thermal Impendance, Junction to Case, TO-220/TO-251/TO-252

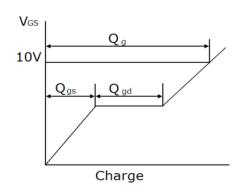


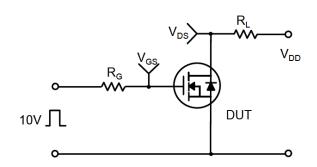
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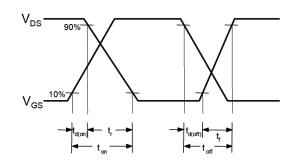


Gate Charge Test Circuit & Waveform

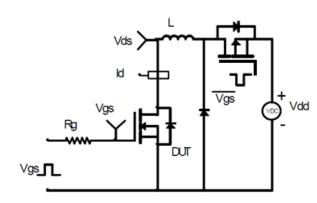


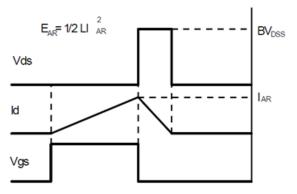






Unclamped Inductive Switching Test Circuit & Waveforms



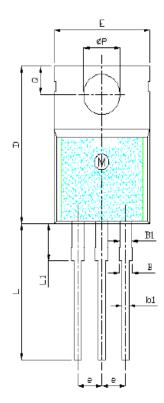


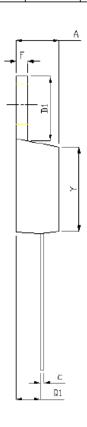
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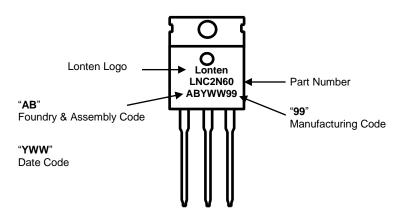
Mechanical Dimensions for TO-220

						UNIT	: mm
SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	4		4. 8	е	2. 44	2. 54	2. 64
В	1. 2		1.4	F	1.1		1.4
B1	1		1.4	L	12.5		14.5
b1	0. 75		0. 95	L1	3	3. 5	4
С	0.4		0. 55	ФР	3.7	3. 8	3. 9
D	15		16. 5	Q	2.5		3
D1	5. 9		6. 9	Q1	2		2. 9
E	9.9		10. 7	Y	8. 02	8. 12	8. 22





TO-220 Part Marking Information

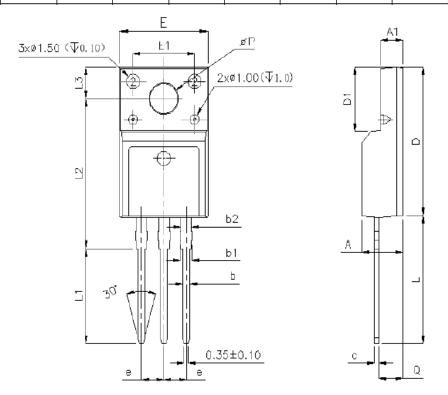


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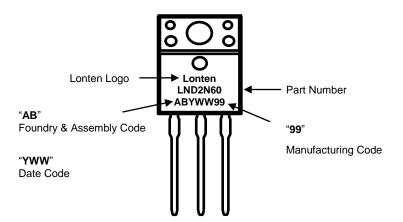


Mechanical Dimensions for TO-220F

					UNIT: mm		
SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	4.5		4. 9	E1	6.5	7	7. 5
A1	2. 3		2. 9	е	2. 44	2. 54	2. 64
b	0. 65		0. 9	L	12.5		14.3
b1	1.1		1.7	L1	9. 45		10. 05
b2	1.2		1. 4	L2	15		16
С	0.35		0. 65	L3	3. 2		4. 4
D	14.5		16. 5	ФР	3		3. 3
D1	6.1		6. 9	Q	2.5		2. 9
E	9.6		10. 3				



TO-220F Part Marking Information

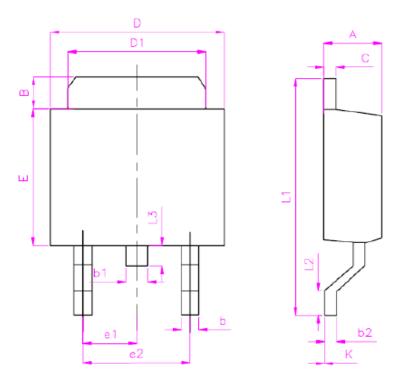


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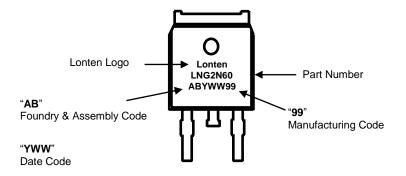


Mechanical Dimensions for TO-252

						UNIT	: mm
SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	2. 10		2.50	E	5. 80		6. 30
В	0. 80		1. 25	e1	2. 25	2. 30	2. 35
b	0. 50		0.85	e2	4. 45		4. 75
b1	0. 50		0.90	L1	9. 50		10. 20
b2	0. 45		0.60	L2	0. 90		1.45
С	0. 45		0.60	L3	0. 60		1. 10
D	6. 35		6. 75	K	-0. 1		0.10
D1	5. 10		5. 50				



TO-252 Part Marking Information

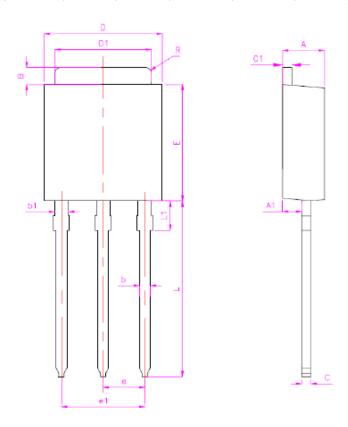


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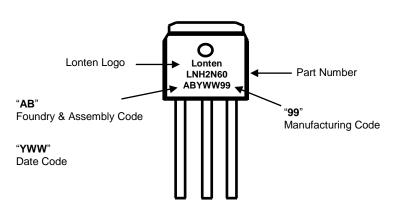


Mechanical Dimensions for TO-251

						UNIT	: mm
SYMBOL	MIN	NOM	MAX	SYMBOL	MIN	NOM	MAX
A	2. 10		2.50	D1	5. 10		5. 50
A1	0. 95		1.30	E	5. 80		6. 30
В	0. 80		1. 25	е	2. 25	2. 30	2. 35
b	0. 50		0.80	L	7. 70		8. 50
b1	0. 70		0.90	L1	1. 45		1. 95
С	0. 45		0.60	R		0.30	
C1	0. 45		0.60				
D	6. 35		6. 75				



TO-251 Part Marking Information



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